



MATERIALS

HOUSING: HI-TEMP PLASTIC (UL 94V-0)
 SHELL: SPCC, NICKEL PLATING
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
 TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 1.5 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 30m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -40°C~+85°C

RECOMMENDED PCB LAYOUT

RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准 Hedy	SCALE 比例 參考	TOLERANCE 容許公差 X ±0.30 XX ±0.25 XXX ±0.150 Ang. ±2°	PART NAME 品名 USB A TYPE 3.0 VERSION 9P MALE OFFSET H=1.9mm SMT TYPE SELECTIVE GOLD 30U" PLATING BLUE INSULATOR INSULATOR MATERIAL PBT ROHS
DWG. 製圖 Yumi		UNIT 單位 M M	PART NO. 料號 C8342-09AMDPIAR
DATE 制表日 2011/05/24	PAGE 張數 1 OF 1	REV. 版次 B	